Fubon ETF Series OFC
Fubon NYSE FactSet Taiwan Core Semiconductor Index ETF

Stock Code: 3076
As of 28/2/2026

富邦基金 Fubon Fund Management

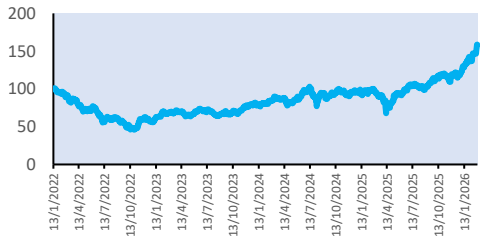
Important Information

- Fubon NYSE FactSet Taiwan Core Semiconductor Index ETF (the "**Sub-Fund**") is a sub-fund of Fubon ETF Series OFC (the "**Company**"), which is a public umbrella open-ended fund company established under Hong Kong law with variable capital with limited liability and segregated liability between sub-funds.
- Registration with and authorisation by the SFC do not represent a recommendation or endorsement of the Company or the Sub-Fund nor do they guarantee the commercial merits of the Company, the Sub-Fund or their performance. They do not mean the Company or the Sub-Fund are suitable for all investors nor do they represent an endorsement of their suitability for any particular investor or class of investors.
- The Sub-Fund is a passively managed index tracking exchange traded fund ("**ETF**") It is denominated in USD and offers shares in both listed and unlisted classes. Shares in the listed class are traded in HKD on The Stock Exchange of Hong Kong Limited (the "**SEHK**").
- The investment objective of the Sub-Fund is to provide investment results that, before deduction of fees and expenses, closely correspond to the performance of the NYSE FactSet Taiwan Core Semiconductor 10% OTC Capped Index ("**Index**") which tracks the performance of listed Taiwan companies involved in the semiconductor industry. There is no assurance that the Sub-Fund will achieve its investment objective.
- The Sub-Fund's investments are concentrated in Taiwan listed companies in the semiconductor industry. The value of the Sub-Fund is subject to risks associated with Taiwan and emerging markets, as well as concentration risk. It may be more volatile than that of a fund investing in more developed markets and / or having a more diverse investment portfolio.
- The Sub-Fund is subject to risks associated with the semiconductor industry, such as intense competition in the industry, rapid obsolescence of products, substantial capital expenditures, government intervention and trade protectionism, etc. These may harm the business and operating results of semiconductor companies.
- The Index is a new index and therefore the Sub-Fund may be riskier than other ETFs tracking more established indices with longer operating history.
- The Sub-Fund is subject to risk associated with small-capitalisation / mid-capitalisation companies. The prices of such companies are more volatile to adverse economic developments than those of larger capitalisation companies in general.
- The Sub-Fund is passively managed and the Manager / Sub-Manager will not have the discretion to adapt to market changes nor take defensive positions in declining markets. It may also be subject to tracking error risk.
- Investors in shares of the listed class and unlisted classes are subject to different pricing and dealing arrangements. The net asset value per share in respect of the listed class and unlisted classes may be different due to different fees and cost applicable to each class.
- The listed class of the Sub-Fund is subject to trading risks that shares in the listed class may trade at a substantial premium or discount to their net asset value. It is also subject to trading time differences risk due to the different trading hours of SEHK and the Taiwan Stock Exchange. This may increase the level of premium/discount of the share price to its net asset value.
- The Sub-Fund is also subject to equity market risk, currency risk, early termination risk and (in respect of the listed class) reliance on market maker risks.
- The Manager may, at its discretion, pay distributions out of capital or out of gross income while all or part of the fees and expenses are charged to capital, resulting in an increase in distributable income for the payment of distributions and therefore, distributions may be paid effectively out of capital. Payment of dividends out of capital and/or effectively out of capital amounts to a return or withdrawal of part of an investor's original investment or from any capital gains attributable to that original investments. Any such distributions may result in an immediate reduction of the net asset value per share of the relevant class.
- Investment involves risks and your investment in the Sub-Fund may suffer losses. You should not make investment decision on the basis of this material alone. Please read the prospectus and the product key facts statement of the Sub-Fund for further details including the risk factors.

Investment Objective

The investment objective of the Sub-Fund is to provide investment results that, before deduction of fees and expenses, closely correspond to the performance of the NYSE FactSet Taiwan Core Semiconductor 10% OTC Capped Index ("Index") which tracks the performance of listed Taiwan companies involved in the semiconductor industry. There is no assurance that the Sub-Fund will achieve its investment objective.

Performance History (%)



The figure show as a NAV change of the Sub-Fund based on a hypothetical 100 investment in the Sub-Fund.

Top 10 Holdings (%)

Taiwan Semiconductor Manufacturing Co., Ltd.	23.99
WinWay Technology Co., Ltd.	8.85
ASE Technology Holding Co., Ltd	8.27
Global Unichip Corp.	7.75
MediaTek Inc.	6.12
TOPCO SCIENTIFIC Co., Ltd.	4.08
Novatek Microelectronics Corp.	4.06
Realtek Semiconductor Corp	3.78
Kinik Company	3.77
Cash and Cash Equivalents (USD)	3.14

Fund Information

Listing Date	13 January 2022
Exchange Listing	SEHK – Main Board
Base Currency	USD
Trading Currency	HKD
Index	NYSE FactSet Taiwan Core Semiconductor 10% OTC Capped Index (Net Total Return)
Fund Size (Mil)	USD 3.64
NAV per Share	USD 1.5822
Distribution Frequency	Subject to the Manager's discretion. Currently the Manager does not intend to pay or make any distributions or dividends.

Current Charge

Management fee	0.6% p.a.

Codes

Stock Code	3076
ISIN	HK0000817103
Bloomberg	3076.HK

Cumulative Performance (%)

3-month	6-month	YTD	1-Year	3-Year	5-Year	Since Listing
32.69	54.00	29.91	64.76	131.75	N/A	58.22

Calendar Year Performance (%)

2025	2024	2023	2022	2021
26.85	-3.99	45.94	N/A	N/A

Sub-Fund performance is calculated on a Net Asset Value (NAV) basis, with income reinvested, net of fees. Performance is calculated in the Sub-Fund currency. Source: Fubon. Past performance is not a guide to future performance and should not be the sole factor of consideration when selecting a product. Investors may not get back the full amount invested.

Sectors (%)

Semiconductors & Semiconductor Equipment	89.18
Machinery, Equipment & Components	6.42
Cash and Cash Equivalents	3.14
Electronic Equipment, Instruments & Components	1.00
Other	0.26

Source: Fubon Fund Management (Hong Kong) Limited. The information contained in this document is for information purposes only and does not constitute any recommendation, offer or solicitation to buy, sell or subscribe to any securities or financial instruments in any jurisdiction.
References to particular sectors, securities or companies are for general information and illustrative purposes only and are not recommendations to buy or sell a security, or an indication of the issuer's holdings at any one time.
Investment involves risks. Past performance is not indicative of future performance. Please refer to the prospectus and the product key facts statement of the Sub-Fund for further details including the risk factors. This document is issued by Fubon Fund Management (Hong Kong) Limited and it has not been reviewed by the Securities and Futures Commission ("SFC").
For more information, please visit www.fubonetf.com.hk today. (This website has not been reviewed by the SFC)

富邦交易所買賣基金系列開放式基金型公司
富邦NYSE FactSet 台灣核心半導體指數ETF

股份代號：3076

資料截至 28/2/2026

富邦基金 Fubon Fund Management

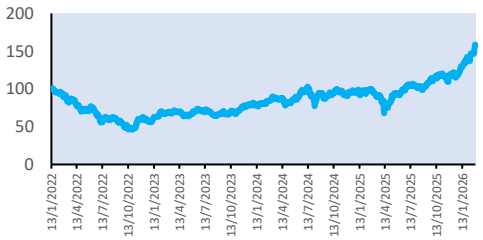
重要事項

- 富邦NYSE FactSet 台灣核心半導體指數ETF（「**子基金**」）為富邦交易所買賣基金系列開放式基金型公司（「**本公司**」）之子基金，本子基金根據香港法律成立，具有可變動股本、有限責任且與子基金之間的法律責任分隔的公眾傘子開放式基金型公司。
- 證監會的登記及認可並不等於對本公司或子基金作出推薦或認許，亦不代表其對本公司、子基金的商業利弊或其表現作出保證。這不表示本公司或子基金適合所有投資者，或認許其適合任何特定投資者或任何類別的投資者。
- 子基金是被動式管理指數追踪交易所買賣基金（「**ETF**」）。子基金以美元計價並同時發售上市類別及非上市類別之股份。上市類別股份以港元交易，於香港聯合交易所有限公司（「**聯交所**」）買賣。
- 子基金的投資目標是提供緊貼NYSE FactSet台灣核心半導體10%場外交易權重上限指數（「**指數**」）表現的投資成績（扣除收費及開支前），指數跟蹤台灣上市的半導體行業的表現。概不保證子基金將達到其投資目標。
- 子基金之投資集中於台灣上市的半導體行業。子基金之價值須承受與台灣及新興市場相關的風險，以及集中風險，波幅可能會較投資於發達國家及／或多元化分散投資的基金更高。
- 子基金須承受半導體行業相關的風險，例如行業激烈競爭、半導體行業迅速發展的特質令產品容易過時、龐大資本設備開支、政府干預、貿易保護主義等，此等因素或會有損半導體公司的業務和營運業績。
- 指數乃成立的新指數，與其他跟蹤有較長運作歷史且較具規模的指數的交易所買賣基金相比，子基金或須承受較高風險。
- 子基金之價值須承受與細市值／中市值企業相關的風險。一般而言，相對於市值較大的公司，該等公司股價因更易受不利經濟形勢的影響而較為波動。
- 子基金以被動方式管理，經理人及分經理人未能酌情對市場變化作出調適，以及不會在市場下跌時採取防禦措施。子基金亦須承受跟蹤誤差風險。
- 上市類別及非上市類別之股份的投資者須受不同的定價及交易安排所規限。由於適用於各類別的費用及成本安排不同，各上市類別及非上市類別的每股資產淨值或會有所不同。
- 子基金的上市類別須承受其上市類別股份可能按子基金資產淨值的重大溢價或折價進行買賣的交易風險，另外亦須承受聯交所及台證所的交易時段有所不同而出現的交易時段差異的風險，此或會增加股份價格相對於其資產淨值的溢價／折讓程度。
- 子基金亦須承受股市風險、貨幣風險、提前終止的風險及（就上市類別而言）對市場莊家依賴的風險。
- 經理人可酌情決定從資本或總收入中撥付股息，而子基金的全部或部分費用及開支則從資本中支付，導致供派付股息的可分派收入有所增加，因此分派可以有效地從資本中支付。從資本中及／或實際上從資本中支付股息，等於投資者獲得部分原投資額回報或撤回其部分原投資額或可歸屬於該原投資額的任何資本收益。任何該些分派，可能導致子基金之相關類別的每股股份資產淨值即時減少。
- 投資涉及風險，閣下於子基金的投資或會蒙受損失。 閣下不應僅就此資料而作出投資決定。 閣下請參閱子基金之章程以及產品資料概要以瞭解包括風險因素之子基金的進一步資料。

投資目標

子基金的投資目標是提供緊貼NYSE FactSet台灣核心半導體10%場外交易權重上限指數（「指數」）表現的投資成績（扣除收費及開支前），指數跟蹤台灣上市的半導體行業的表現。概不保證子基金將達到其投資目標。

基金以往表現 (%)



有關數據顯示對子基金進行100元假設投資的資產淨值變動。

十大持股 (%)

台積電	23.99
穎崴科技	8.85
日月光半導體	8.27
創意電子	7.75
聯發科技	6.12
崇越科技	4.08
聯詠科技	4.06
瑞昱半導體	3.78
中國砂輪	3.77
現金及現金等價物	3.14

基金資料

上市日期	2022年1月13日
上市交易所	聯交所 - 主板
基準貨幣	美元
交易貨幣	港元
指數	NYSE FactSet台灣核心半導體10%場外交易權重上限指數（淨總回報）
總資產值(百萬)	3.64美元
每股資產淨值	1.5822美元
分派頻率	由經理人酌情釐定。目前經理人不擬派付或作出任何分派或股息。
現時費用	
管理費	每年0.6%
編號	
股份代號	3076
ISIN	HK0000817103
Bloomberg	3076.HK

累積表現(%)

3個月	6個月	年初至今	1年	3年	5年	上市自今
32.69	54.00	29.91	64.76	131.75	不適用	58.22

年度表現(%)

2025	2024	2023	2022	2021
26.85	-3.99	45.94	不適用	不適用

子基金表現按資產淨值比資產淨值基礎計算，將收入再作投資，已扣除費用。表現以子基金的計值貨幣計算。資料來源：富邦 。過往表現並非未來表現的指引，不應作為選擇一項產品的唯一考慮因素。投資者可能無法取回全數投資金額。

行業 (%)

半導體及半導體設備	89.18
機械、設備和部件	6.42
現金及現金等價物	3.14
電子設備、儀器和部件	1.00
其他	0.26

資料來源：富邦基金管理（香港）有限公司。本文件所載資料僅供說明用途，並不構成於任何司法管轄區購買、銷售或認購任何證券或財務工具的任何建議、提呈或邀約。
文內所提及個別行業、證券或公司僅作一般資料及說明用途，並不是建議買賣有關證券，或代表發行人在任何時期持有該投資。
投資涉及風險。過去業績並不代表將來表現。請參閱基金章程及產品資料概要以了解風險因素等詳情。本文件由富邦基金管理（香港）有限公司刊發，未經證監會審閱。
查詢詳情，請瀏覽www.fubonetf.com.hk（此網站未經證監會審閱。）